

APPLICATION DATA SHEET

INVENTOR INFORMATION

Inventor one given name::

Koki

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Country::

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Inventor two given name::

Takeshi

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SHIRATO

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Postal or Zip Code::

100-8220

City of residence::

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Country of residence::

Japan

Citizenship Country::

Japan

CORRESPONDENCE INFORMATION

Correspondence customer number:: 23911

APPLICATION INFORMATION

Title line one::

Title line two::

THE MULTILAYER ELECTRONIC SUBSTRATE, AND THE METHOD OF MANUFACTURING MULTILAYER

Title line three:: Title line four::

ELECTRONIC SUBSTRATE

Total drawing sheets::

8 Yes

Formal drawings?::

-1-

Application type::
Docket Number::

Utility

056203.52845US

REPRESENTATIVE INFORMATION

Representative customer number:: 23911

PRIOR FOREIGN APPLICATIONS

Foreign application one::

2002-302229

Filing date::

October 16, 2002

Country::

Japan

Priority claimed::

Yes